

The RF Line

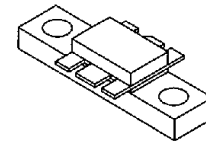
UHF Linear Power Transistor

... designed for 24 Volt UHF large-signal common emitter amplifier applications in industrial and commercial FM equipment operating in the 380 to 512 MHz frequency range, i.e., cellular radio base stations.

- 380–512 MHz
- 15 W — P_{out}
- 24 V — V_{CC}
- High Gain — 11 dB Min, Class AB
- Gold Metallization for Reliability

TP5015

15 W, 380–512 MHz
UHF LINEAR
POWER TRANSISTOR
NPN SILICON



CASE 319-07, STYLE 2
(EB)

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Total Device Dissipation @ $T_C = 70^\circ\text{C}$ Derate above 70°C	P_D	18 0.143	Watts W/ $^\circ\text{C}$
Operating Junction Temperature	T_J	200	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	–65 to +200	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case ($T_C = 70^\circ\text{C}$)	$R_{\theta JC}$	7.0	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Emitter–Base Breakdown Voltage ($I_E = 5.0\text{ mA}$, $I_C = 0$)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector–Emitter Breakdown Voltage ($I_C = 10\text{ mA}$, $R_{BE} = 75\ \Omega$)	$V_{(BR)CER}$	40	—	—	Vdc
Collector–Emitter Leakage ($V_{CE} = 26\text{ V}$, $R_{BE} = 75\ \Omega$)	I_{CER}	—	—	10	mAdc

ON CHARACTERISTICS

DC Current Gain ($I_C = 100\text{ mA}$, $V_{CE} = 10\text{ V}$)	h_{FE}	15	—	100	—
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DYNAMIC CHARACTERISTICS

Output Capacitance ($V_{CB} = 24\text{ V}$, $I_E = 0$, $f = 1.0\text{ MHz}$)	C_{ob}	—	16	25	pF
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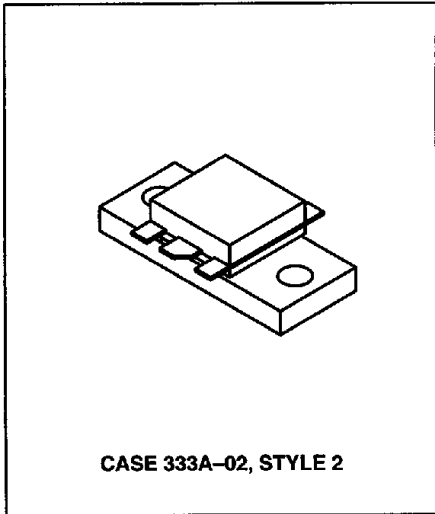
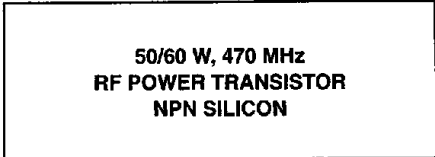
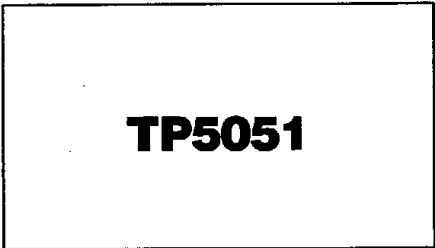
FUNCTIONAL TESTS

Common–Emitter Amplifier Power Gain ($V_{CE} = 24\text{ V}$, $P_{out} = 15\text{ W}$, $f = 470\text{ MHz}$, $I_Q = 50\text{ mA}$)	G_{PE}	11	—	—	dB
Collector Efficiency ($V_{CE} = 24\text{ V}$, $P_{out} = 15\text{ W}$, $f = 470\text{ MHz}$, $I_Q = 50\text{ mA}$)	η_c	50	60	—	%

The RF Line
NPN Silicon
RF Power Transistor

The TP5051 is designed for 470 MHz cellular radio base stations in both analog and digital applications. It incorporates high value emitter ballast resistors, gold metallizations and offers a high degree of reliability and ruggedness.

- Specified 470 MHz Characteristics
 - Output Power — 50 Watts @ 24 Volts, 60 Watts @ 26 Volts
 - Gain — 9 dB min
 - Efficiency — 60% min
 - Class AB or C Operation
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CE}	40	Vdc
Collector-Base Voltage	V _{CBO}	48	Vdc
Emitter-Base Voltage	V _{EBO}	4	Vdc
Collector-Current — Continuous	I _C	10	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	145 0.8	Watts W/°C
Storage Temperature Range	T _{stg}	- 65 to +150	°C
Operating Junction Temperature	T _J	200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case at 70°C Case (1)	R _{θJC}	1.2	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (I _C = 60 mA, R _{BE} = 75 Ω)	V _{(BR)CER}	40	—	—	Vdc
Emitter-Base Breakdown Voltage (I _E = 15 mA)	V _{(BR)EBO}	4	—	—	Vdc
Collector-Base Breakdown Voltage (I _C = 50 mA)	V _{(BR)CBO}	48	—	—	Vdc
Collector-Emitter Leakage (V _{CE} = 26 V, R _{BE} = 75 Ω)	I _{CER}	—	—	15	mA

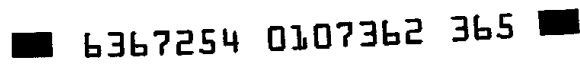
ON CHARACTERISTICS

DC Current Gain (I _C = 1 Adc, V _{CE} = 10 Vdc)	h _{FE}	15	—	80	—
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NOTE:

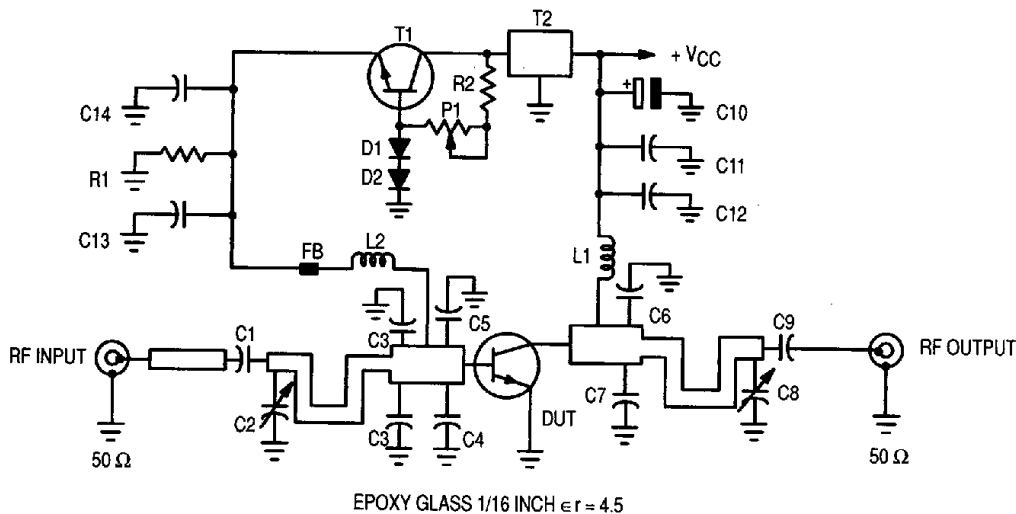
- Thermal resistance is determined under specified RF operating condition.

(continued)



ELECTRICAL CHARACTERISTICS — continued ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

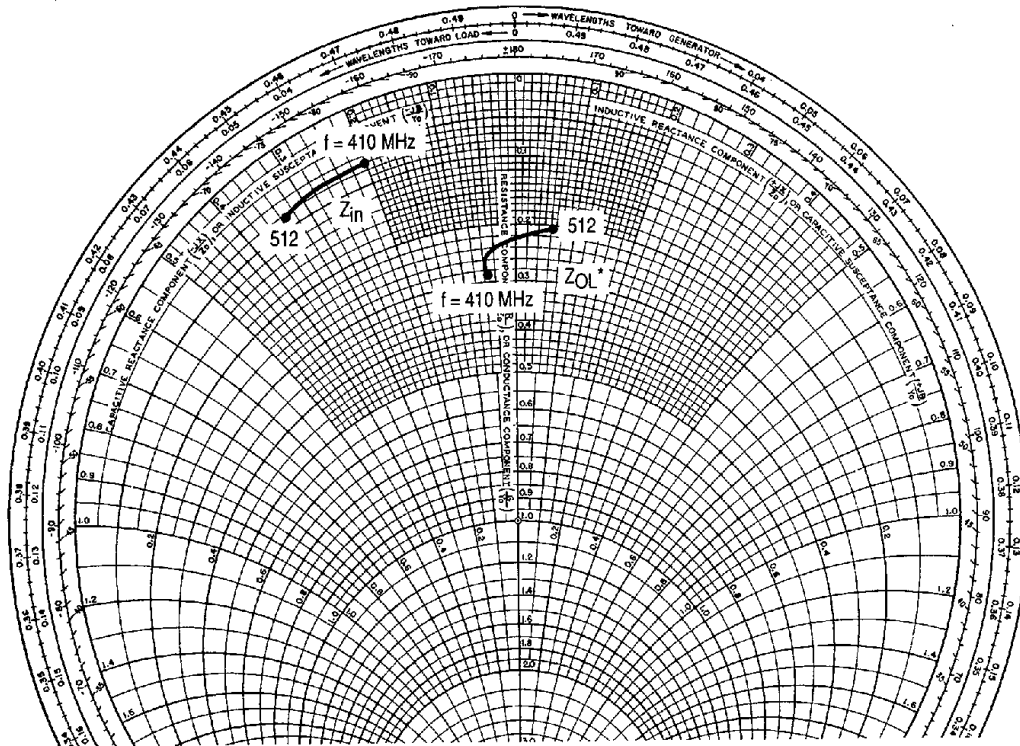
Characteristic	Symbol	Min	Typ	Max	Unit
DYNAMIC CHARACTERISTICS					
Output Capacitance ($V_{CB} = 26\text{ V}$, $I_E = 0$, $f = 1\text{ MHz}$)	C_{ob}	—	60	—	pF
FUNCTIONAL TESTS					
Common-Emitter Amplifier Power Gain ($V_{CC} = 24\text{ V}$, $P_{out} = 50\text{ W}$, $I_{CQ} = 150\text{ mA}$, $f = 470\text{ MHz}$)	G_{p1}	9	10	—	dB
Collector Efficiency ($V_{CC} = 24\text{ V}$, $P_{out} = 50\text{ W}$, $f = 470\text{ MHz}$)	η_1	60	65	—	%
Load Mismatch ($V_{CC} = 24\text{ V}$, $P_{out} = 50\text{ W}$, $I_{CQ} = 150\text{ mA}$ Load VSWR = 5:1, all phase angles at frequency of test)	ψ_1	No Degradation in Output Power			
Overdrive ($V_{CC} = 24\text{ V}$, $P_{in} = 12\text{ W}$, $f = 470\text{ MHz}$)	OD	No Degradation in Output Power			
Power Saturation ($V_{CC} = 24\text{ V}$, $f = 470\text{ MHz}$)	P_{sat}	65	—	—	W
Common-Emitter Amplifier Power Gain ($V_{CC} = 26\text{ V}$, $P_{out} = 60\text{ W}$, $I_{CQ} = 150\text{ mA}$, $f = 470\text{ MHz}$)	G_{p2}	9	10	—	dB
Collector Efficiency ($V_{CC} = 26\text{ V}$, $P_{out} = 60\text{ W}$, $f = 470\text{ MHz}$)	η_2	60	65	—	%
Load Mismatch ($V_{CC} = 26\text{ V}$, $P_{out} = 60\text{ W}$, $I_{CQ} = 150\text{ mA}$ Load VSWR = 5:1, all phase angles at frequency of test)	ψ_2	No Degradation in Output Power			



Components List

C1, C9	330 pF, 5%, Chip Capacitor 0805	D1, D2	Diode, 1N4148
C2, C8	AIRTRONIC Trimmer Capacitor 5400	FB	Ferrite Board
C3	10 pF, ATC Chip Capacitor	L1, L2	6 Turns, #18 AWG ϕ 4 mm Choke
C3'	12 pF, ATC Chip Capacitor	P1	1 k Ω , Trimmer
C4, C5	22 pF, ATC Chip Capacitor	R1	56 Ω , 5%, Chip Resistor 1205
C6	15 pF, ATC Chip Capacitor	R2	470 Ω , 5%, Chip Resistor 0805
C7	18 pF, ATC Chip Capacitor	T1	SMD Transistor, MJD31C or Similar
C10	47 μ F, 63 V, Electrolytic Capacitor	T2	Voltage Regulator 7805
C11, C14	15 nF, Chip Capacitor 0805		
C12, C13	330 pF, 5%, Chip Capacitor 0805		

Figure 1. 470 MHz Electrical Schematic



$P_{out} = 50 \text{ W}$, $V_{CE} = 24 \text{ V}$

f (MHz)	Z_{in} (Ω)	Z_{OL}^* (Ω)
512	$1 - j3.2$	$2 - j0.7$
490	$0.97 - j2.8$	$2.2 - j0.5$
470	$0.9 - j2.7$	$2.4 + j0.13$
450	$0.85 - j2.5$	$2.6 + j0.9$
410	$0.8 - j2.1$	$3 + j0.5$

Figure 2. Series Equivalent Input and Output Impedances

TYPICAL CHARACTERISTICS

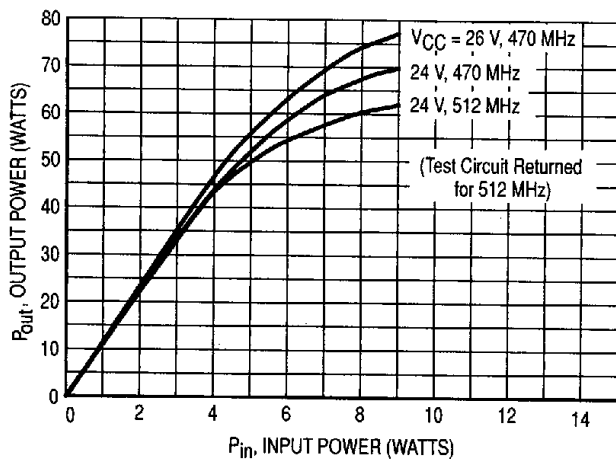


Figure 3. Output Power versus Input Power

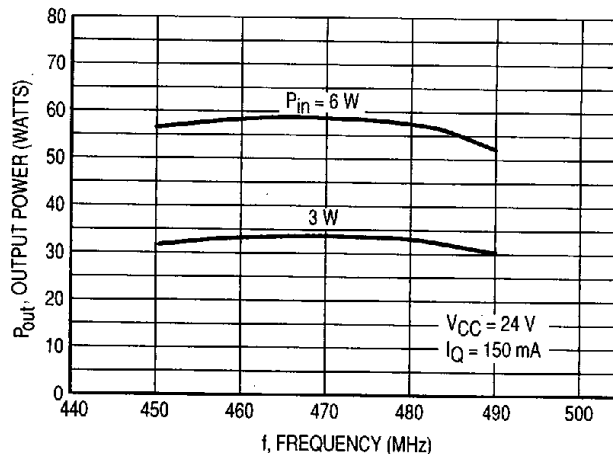


Figure 4. Output Power versus Frequency

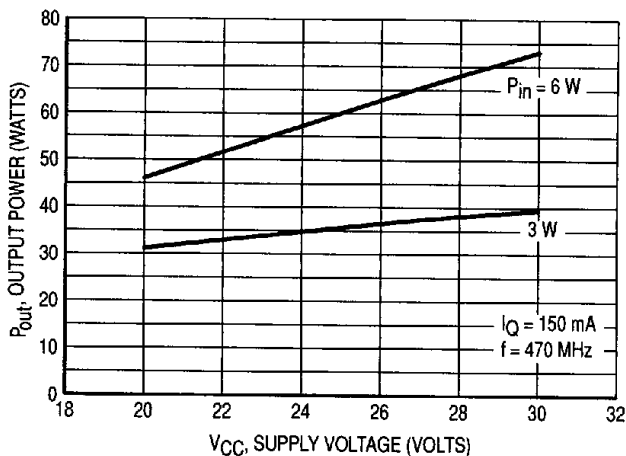


Figure 5. Output Power versus Supply Voltage

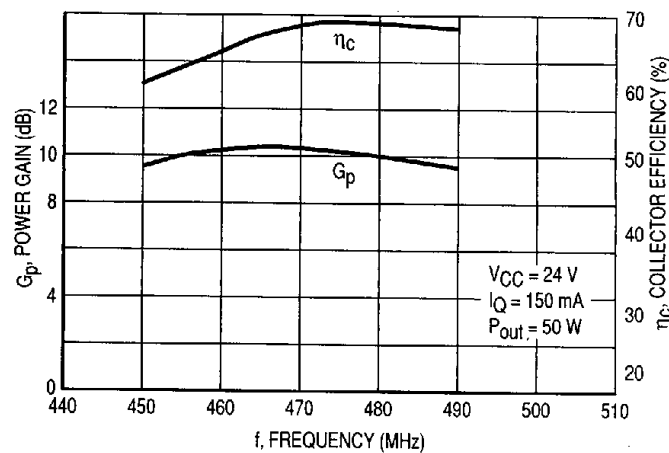
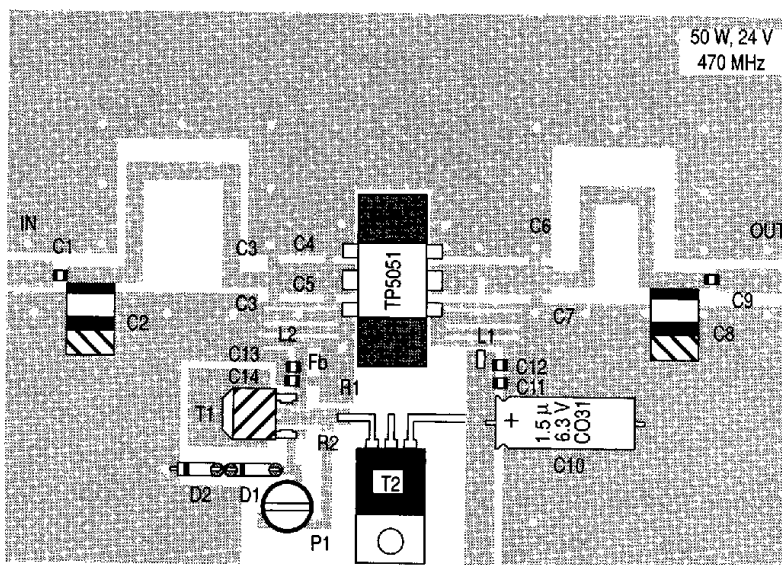


Figure 6. Power Gain, Collector Efficiency versus Frequency



EPOXY GLASS 1/16 INCH $\epsilon_r = 4.5$

Figure 7. 470 MHz Test Circuit Components View